

### Typical Applications

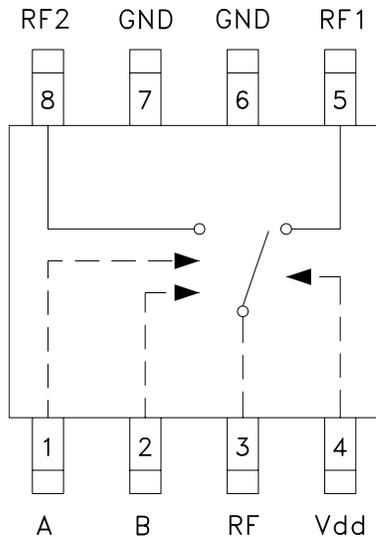
The HMC154S8 / HMC154S8E is ideal for:

- MMDS & WirelessLAN
- Basestation Infrastructure
- Portable Wireless

### Features

- High Third Order Intercept: +60 dBm
- Single Positive Supply: +3 to +10V
- High RF Power Capability
- TTL/CMOS Control

### Functional Diagram



### General Description

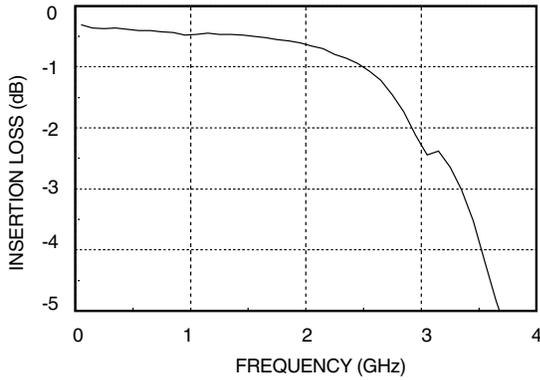
The HMC154S8 & HMC154S8E are low-cost SPDT switches in 8-lead SOIC packages for use in transmit-receive applications which require very low distortion at high signal power levels. The device can control signals from DC to 2.5 GHz and is especially suited for 900 MHz and 1.8 - 2.2 GHz applications. The design provides exceptional intermodulation performance; providing a +60dBm third order intercept at 8 Volt bias. RF1 and RF2 are reflective shorts when "Off". On-chip circuitry allows single positive supply operation at very low DC current with control inputs compatible with CMOS and most TTL logic families.

### Electrical Specifications, $T_A = +25^\circ \text{C}$ , $V_{dd} = +5 \text{Vdc}$ , 50 Ohm System

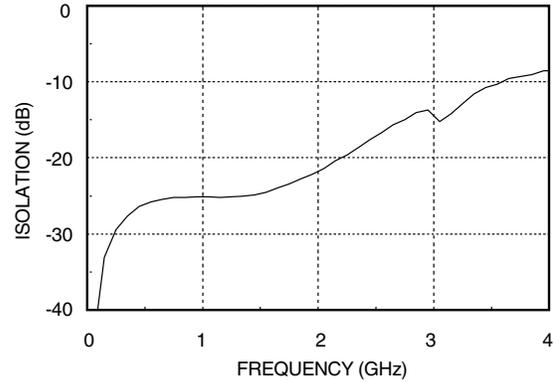
Parameter		Frequency	Min.	Typ.	Max.	Units
Insertion Loss		DC - 1.0 GHz		0.5	0.7	dB
		DC - 2.0 GHz		0.7	0.9	dB
		DC - 2.5 GHz		1.0	1.3	dB
Isolation		DC - 1.0 GHz	22	25		dB
		DC - 2.0 GHz	19	22		dB
		DC - 2.5 GHz	15	18		dB
Return Loss		DC - 1.0 GHz	20	30		dB
		DC - 2.0 GHz	14	18		dB
		DC - 2.5 GHz	10	13		dB
Input Power for 1 dB Compression	0/8V Control	0.5 - 1.0 GHz	35	39		dBm
		0.5 - 2.0 GHz	34	38		dBm
Input Third Order Intercept	0/8V Control	0.5 - 1.0 GHz	55	60		dBm
		0.5 - 2.0 GHz	54	60		dBm
Switching Characteristics		DC - 2.5 GHz	$t_{RISE}, t_{FALL}$ (10/90% RF)		10	ns
			$t_{ON}, t_{OFF}$ (50% CTL to 10/90% RF)		24	ns



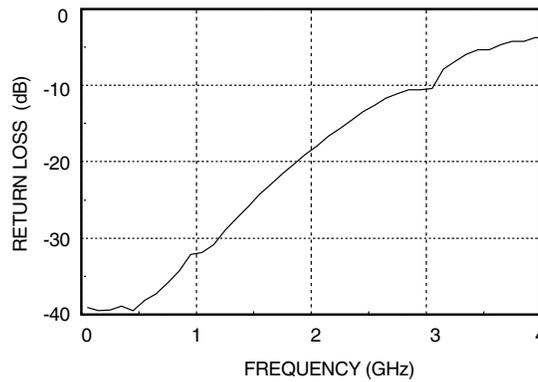
### Insertion Loss



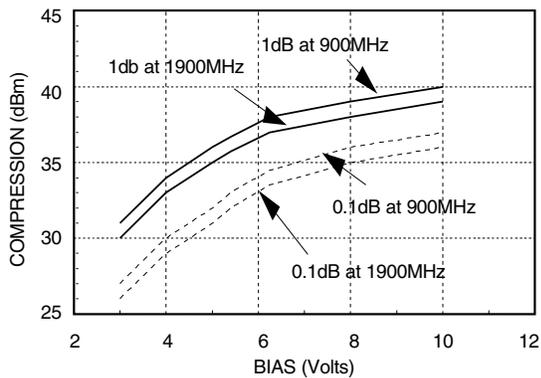
### Isolation



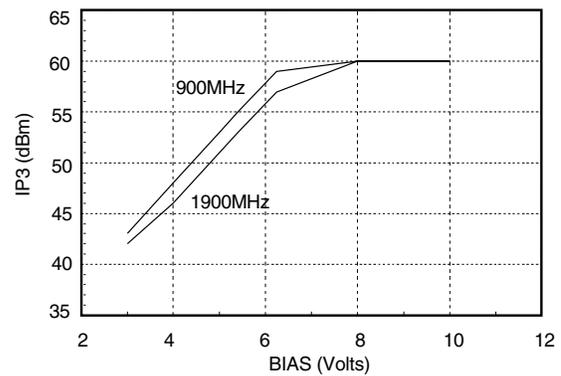
### Return Loss



### Input Power for 0.1 and 1.0 dB Compression vs. Bias Voltage



### Input Third Order Intercept vs. Bias Voltage





### Compression vs. Bias Voltage

Bias Vdd	Carrier at 900 MHz		Carrier at 1900 MHz	
	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression
(Volts)	(dBm)	(dBm)	(dBm)	(dBm)
3	27	31	26	30
4	30	34	29	33
5	32	36	31	35
8	36	39	35	38
10	37	40	36	39

Caution:

Do not operate in 1dB compression at power levels above +35dBm and do not "hot switch" power levels greater than +23dBm (Vdd = +5V).

### Distortion vs. Bias Voltage

Bias Vdd	1 Watt Carrier at 900 MHz			1 Watt Carrier at 1900 MHz		
	Third Order Intercept	Second Order Intercept	Second Harmonic	Third Order Intercept	Second Order Intercept	Second Harmonic
(Volts)	(dBm)	(dBm)	(dBc)	(dBm)	(dBm)	(dBc)
3	43	71	45	42	78	55
4	48	85	55	46	88	65
5	53	90	56	51	87	58
8	60	90	58	60	90	59
10	60	90	59	60	90	60

### Truth Table

\*Control Input Voltage Tolerances are  $\pm 0.2$  Vdc.

Bias Vdd (Vdc)	Control Input*		Bias Current Idd (uA)	Control Current		Signal Path State	
	A (Vdc)	B (Vdc)		Ia (uA)	Ib (uA)	RF to RF1	RF to RF2
3	0	0	30	-15	-15	OFF	OFF
3	0	Vdd	25	-25	0	ON	OFF
3	Vdd	0	25	0	-25	OFF	ON
5	0	0	110	-55	-55	OFF	OFF
5	0	Vdd	115	-100	-15	ON	OFF
5	Vdd	0	115	-15	-100	OFF	ON
10	0	0	380	-190	-190	OFF	OFF
10	0	Vdd	495	-275	-220	ON	OFF
10	Vdd	0	495	-220	-275	OFF	ON
5	-Vdd	Vdd	600	-600	225	ON	OFF
5	Vdd	-Vdd	600	225	-600	OFF	ON

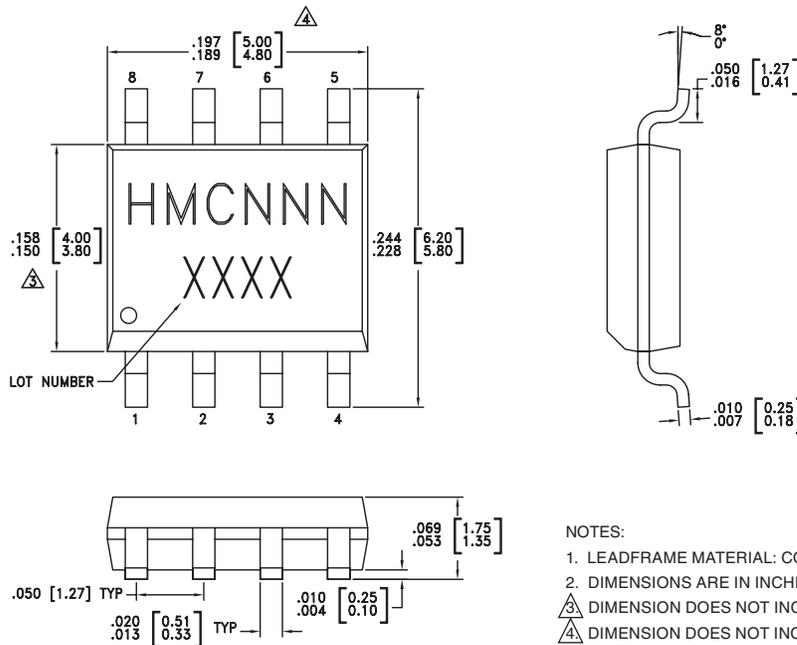
### Absolute Maximum Ratings

Bias Voltage Range (Vdd)	-0.2 to +12 Vdc
Control Voltage Range (A & B)	-0.2 to Vdd Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



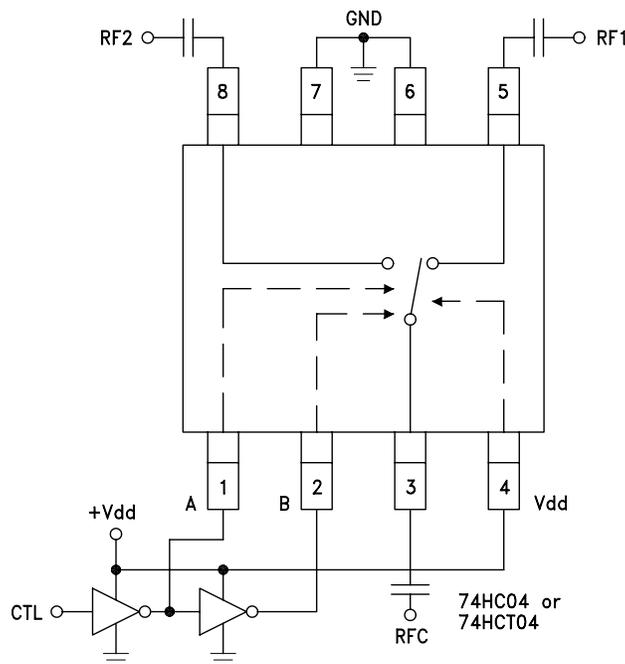
### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC154S8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	HMC154 XXXX
HMC154S8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	HMC154 XXXX

[1] Max peak reflow temperature of 235 °C

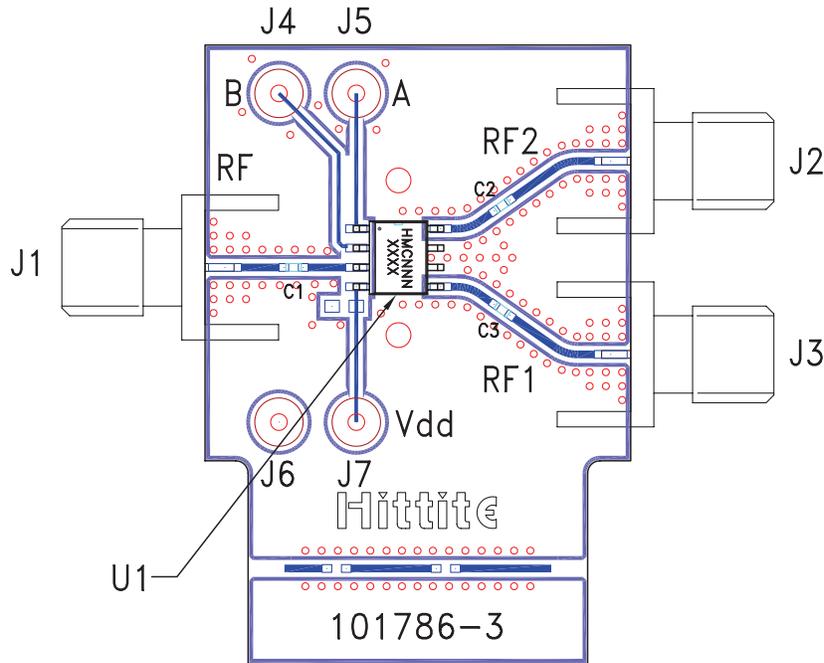
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

**Typical Application Circuit**

**Notes:**

1. Set logic gate and switch Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of 3 to 8 Volts applied to the CMOS logic gates and to pin 4 of the RF switch.
3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
4. Highest RF signal power capability is achieved with V set to +10V. The switch will operate properly (but at lower RF power capability) at bias voltages down to +3V.

**Evaluation Circuit Board**



**List of Materials for Evaluation PCB 101788 [1]**

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4 - J7	DC Pin
C1 - C3	330 pF Capacitor, 0402 Pkg.
U1	HMC154S8 / HMC154S8E SPDT Switch
PCB [2]	101786 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.